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January 2015

FSA2380 — Low R_{ON} (0.75 Ω) 3:1 Negative Swing Audio Source Switch

Features

- 10 μA Maximum I_{CCT} Current Over An Expanded Control Voltage Range (V_{IN}=2.6 V, V_{CC}=4.3 V)
- C_{ON} Capacitance 70 pF Typical
- 0.75 Ω Typical On Resistance (R_{ON})
- 1Bn, 2Bn Ports Support Negative Swing Audio to -2 V
- -3 db Bandwidth: > 120 MHz
- Low Power Consumption (1 μA maximum)
- Power-Off Feature for 1 A/2 A Pin (I_{IN} < 2 μA)</p>
- Packaged in Pb-Free 14-Pin TSSOP and DQFN

Applications

- Cell Phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

Description

The FSA2380 is a Double-Pole, Triple Throw (DP3T) multiplexer that routes three dual-channel sources of data or audio under the control of a single pair of select pins. The FSA2380 has special circuitry on the 1A/2A pins to allow a power-off feature. With the V_{CC} supply removed and voltage on the 1A/2A pins, there is minimal leakage current into the 1A/2A data pins. The FSA2380 also features very low quiescent current and a power-off feature to extend battery life. The low quiescent current feature allows mobile handset applications direct interface with the baseband processor general-purpose I/Os. Typical applications involve switching in portables and consumer applications, such as cell phones, digital cameras, and notebooks with hubs or controllers.

Ordering Information

| Part Number | Top Mark | Packing Description |
|-------------|----------|---|
| FSA2380BQX | 2380 | 14-Terminal Depopulated very thin Quad Flat-pack No leads (DQFN) 2.5 x 3.0 mm, JEDEC MO-241 |
| FSA2380MTCX | FSA2380 | 14-Lead Thin Shrink Small Outline Package (TSSOP) 4.4 mm wide, JEDEC MO-153 |

Analog Symbol

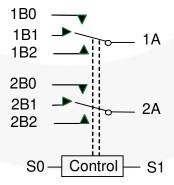
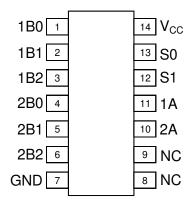


Figure 1. FSA2380 Analog Symbol

Pin Assignments



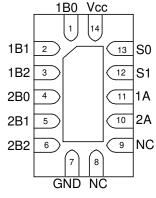


Figure 2. TSSOP-14 (Top Through View)

Figure 3. DQFN-14 (Top Through View)

Pin Descriptions

| Name | Description |
|----------|---------------------------|
| S0, S1 | Switch Control Selects |
| 1A, 2A | A Data Bus (Common) |
| 1Bn, 2Bn | Multiplexed Source inputs |

Truth Table

| S1 | S0 | Function |
|------------------|------------------|---------------------|
| LOW Logic Level | LOW Logic Level | Disconnected (Hi-Z) |
| LOW Logic Level | HIGH Logic Level | 1B0 = 1A; 2B0 = 2A |
| HIGH Logic Level | LOW Logic Level | 1B1 = 1A; 2B1 = 2A |
| HIGH Logic Level | HIGH Logic Level | 1B2 = 1A; 2B2 = 2A |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | | Min. | Max. | Unit |
|---------------------|--|-----------------|----------------------|----------------------|------|
| V _{CC} | Supply Voltage | | -0.5 | 6.0 | V |
| V | Switch I/O Voltage ⁽¹⁾ | 1Bn, 2Bn Pins | V _{CC} -5.5 | V _{CC} +0.3 | V |
| V _{SW} | Switch i/O voltage | 1A, 2A Pins | V _{CC} -5.5 | V _{CC} +0.3 | V |
| V _{CNTRL} | Control Input Voltage ⁽¹⁾ S0, S1 Pins | | -0.5 | 6.0 | V |
| I _{IK} | Input Clamp Diode Current | | -50 | | mA |
| I _{SW} | Switch I/O Current (Continuous) | | | 350 | mA |
| I _{SWPEAK} | Peak Switch Current (Pulsed at 1ms Duration, < | 10% Duty Cycle) | | 500 | mA |
| ь / | B B: : :: : : : : : : : : : : : : : : : | DQFN-14 | | 2.5 | μW |
| P _D | Power Dissipation at 85°C | TSSOP-14 | | 2.5 | μW |
| T _{STG} | Storage Temperature Range | | -65 | +150 | °C |
| TJ | Maximum Junction Temperature | | 1 | +150 | °C |
| TL | Lead Temperature (Soldering, 10 seconds) | | | +260 | °C |
| | | All Pins | | 5500 | |
| ESD | Human Body Model (JEDEC: JESD22-A114) | I/O to GND | | 8000 | kV |
| | | VCC to GND | | 8000 | |
| | Charged Device Model (JEDEC-JESD22-C101) | | | 2000 | kV |

Note:

 The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | | Min. | Max. | Unit |
|--------------------|---|---------|----------------------|-----------------|------|
| Vcc | Supply Voltage | | 2.7 | 5.0 | V |
| V _{CNTRL} | Control Input Voltage (V _{S0:S1}) | | 0 | V _{CC} | V |
| V_{SW} | Switch I/O Voltage | | V _{CC} -5.5 | V _{CC} | |
| T _A | Operating Temperature | | -40 | +85 | °C |
| θЈА | Thermal Decistores (free cir.) | DQFN-14 | | 1.45 | °C/W |
| | Thermal Resistance (free air) TSSOP-14 | | | 145 | C/VV |

DC Electrical Characteristics

All typical values are at 25°C unless otherwise specified.

| | D | 0 1111 | V 00 | T _A = - 40°C to +85°C | | | 11 |
|-----------------------|---|---|--------------------------|----------------------------------|------|-----------------|------|
| Symbol | Parameter | Conditions | V _{cc} (V) | Min. | Тур. | Max. | Unit |
| | Analog Signal Range | | | V _{CC} - 5.5 | | V _{CC} | V |
| V _{IK} | Clamp Diode Voltage | | | | | 1.2 | V |
| V _{IH} | Control Input Voltage HIGH | | 2.7 to 3.6 3.6 to 4.3 | 1.2 1.5 | | | |
| V _{IL} | Control Input Voltage LOW | | 2.7 to 3.6 3.6 to 4.3 | | | 0.5 0.7 | V |
| I _{IN} | Control Input Leakage | $V_{\text{IN}} = 0 \text{ to } V_{\text{CC}}$ | 4.3 | 1 | | ±1 | μΑ |
| l _{OFF} | Power Off Leakage Current (Common Port Only 1A, 2A) | Common Port (1A, 2A) V _{SW} = 0 to 4.3 V V _{CC} = 0 V | 0V | | | ±10 | μА |
| I _{NO(0FF)} | Off-Leakage Current of Port (1Bn, 2Bn) | 1Bn, 2Bn or 1A, 2A = 0.3 V, V _{CC} -0.5 V, or Floating | 4.3 | -50 | 10 | 50 | nA |
| I _{NC(0N)} | On-Leakage Current of Port 1Bn, 2Bn | 1Bn, 2Bn or 1A, 2 A = 0.3 V, V _{CC} -0.5 V, or Floating | 4.3 | -50 | 10 | 50 | nA |
| R _{ON} | Switch On Resistance ⁽²⁾ | 1Bn or 2Bn = 0 V, 0.7 V, 2.0 V, 2.7 V; I _{ON} = - 100 mA | 2.70 | | 0.75 | 2.00 | Ω |
| ΔR _{ON} | Delta On Resistance ⁽³⁾ | See Figure 7, Figure 8 1Bn or 2Bn = 0.7 V, Vcc, IoN = -100 mA | 2.70 | | 0.50 | | Ω |
| R _{FLAT(ON)} | On Resistance Flatness ⁽⁴⁾ | 1Bn or 2Bn = 0V, 0.7 V, 2.0 V, 2.7 V; I _{ON} = -100 mA | 2.7 to 4.3 | | 0.23 | 0.40 | Ω |
| I _{CC} | Quiescent Supply Current | See Figure 7, Figure 8 $V_{SW} = 0$ or V_{CC} -0.3 $I_{OUT} = 0$ | 4.3 | | 22 | 500 | nA |
| | Increate in Quiescent | V _{CNTRL} = 2.6 V | - 1 | | 2.0 | 10.0 | |
| Ісст | Supply Current per Control Voltage and V _{CC} | V _{CNTRL} = 1.8 V | 4.3 | | 6.5 | 15.0 | μΑ |

Notes:

- 2. R_{ON} measured by the voltage drop between 1Bn (2Bn) and 1A (2A) pins at identical current through the switch. R_{ON} is determined by the lower of the voltage on the two pins.
- 3. Guaranteed by characterization, not production tested.
- 4. Flatness is defined as the difference between the maximum and minimum values of on resistance over the specified range of conditions.

AC Electrical Characteristics

All typical value are for $V_{\text{CC}} = 3.3 \text{ V}$ at 25°C unless otherwise specified.

| Symbol | Parameter | Conditions | V _{cc} (V) | T _A = - 40°C to +85°C | | | Unit |
|------------------|-----------------------------------|--|---------------------|-------------------------------------|------|------|------|
| | | | | Min. | Тур. | Max. | |
| t _{ON} | Turn-On Time S[0:1] to Output | $V_{Bn} = 1.5 \text{ V}, R_L = 50\Omega,$ $C_L = 35 \text{ pF}$ Figure 10, Figure 12 | 2.7 to 4.3 | | 30 | 60 | ns |
| t _{OFF} | Turn-Off Time S[0:1] to Output | $V_{Bn} = 1.5 \text{ V}, R_L = 50\Omega,$ $C_L = 35 \text{ pF}$ Figure 10, Figure 12 | 2.7 to 4.3 | | 22 | 45 | ns |
| t _{PD} | Propagation Delay ⁽⁵⁾ | $R_L = 50 \Omega$, $C_L = 5 pF$ Figure 13 | 3.3 | | 0.25 | | ns |
| t _{BBM} | Break-Before-Make ⁽⁵⁾ | $R_L = 50 \ \Omega, \ C_L = 5 \ pF$ $V_{IN1} = V_{IN2} = V_{IN3} = 1.5 \ V$ Figure 11 | 2.7 to 4.3 | 1 | 6 | | ns |
| Q | Charge Injection | $R_{GEN} = 0 \Omega$, $C_L = 100 pF$, $R_L = OPEN$ Figure 14 | 2.7 to 4.3 | | 9 | | рС |
| O _{IRR} | Off-Isolation | $f = 100$ kHz, $R_L = 50$ Ω Figure 4, Figure 16 | 2.7 to 4.3 | | -68 | | dB |
| Xtalk | Non-Adjacent Channel Crosstalk | $f = 100 \text{ kHz}, R_L = 50 \Omega$ Figure 5, Figure 17 | 2.7 to 4.3 | | -60 | | dB |
| THD | Total Harmonic Distortion | $ f = 20 \text{ Hz to } 20 \text{ kHz}, \\ R_L = 600 \ \Omega, V_{SW} = 0.5 V_{pp}, \\ Figure \ 20 $ | 2.7 to 4.3 | | 0.01 | | % |
| BW | -3 db Bandwidth | $R_L = 50 \Omega$, $C_L = 0, 5 pF$ Figure 6, Figure 15 | 2.7 to 4.3 | | 120 | | MHz |

Note:

5. Guaranteed by characterization, not production tested.

Capacitance

| Symbol | Davamatav | Conditions | T _A = - 40°C to +85°C | Unit |
|-------------------|-------------------------------|--|----------------------------------|------|
| | Parameter | Conditions | Typical | |
| C _{IN} | Control Pin Input Capacitance | V _{CC} = 0 V | 2.75 | рF |
| C _{ON} | A/B On Capacitance | V _{CC} = 3.3 V; S[0:1] = 01, 10, 11; f = 1 MHz | 70 | pF |
| | | Figure 19 | | |
| C _{OFFA} | Port 1A, 2A Off Capacitance | V _{CC} = 3.3 V, S[0:1] = 00 Figure 18 | 42 | pF |
| C _{OFFB} | Port 1Bn, 2Bn Off Capacitance | V _{CC} = 3.3 V, S[0:1] = 00 Figure 18 | 20 | pF |

Typical Characteristics

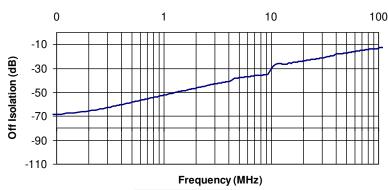


Figure 4. Off Isolation $V_{CC} = 3.3 \text{ V}, C_L = 0 \text{ pF}$

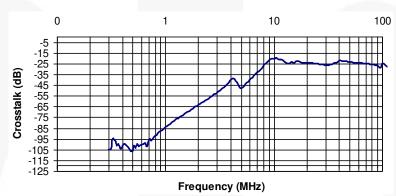


Figure 5. Non-Adjacent Crosstalk V_{CC} = 3.3 V,C_L = 0 pF

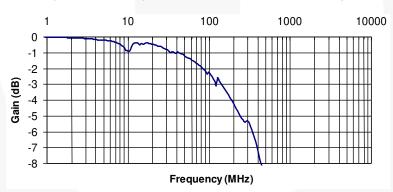
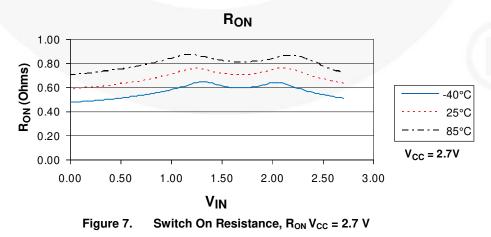
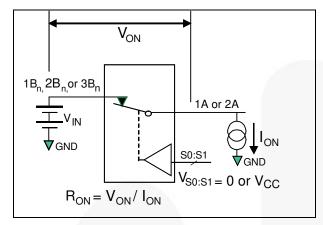


Figure 6. Bandwidth $V_{CC} = 3.3 \text{ V}, C_L = 0 \text{ pF}$



Test Diagrams



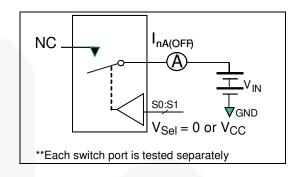
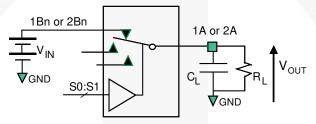


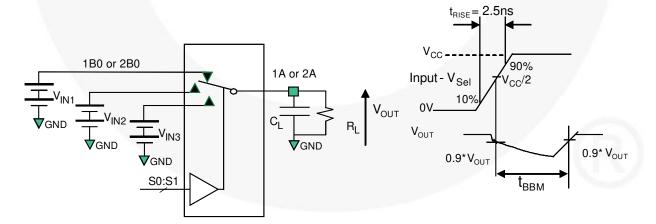
Figure 8. On Resistance

Figure 9. Off Leakage



 $\rm R_L$ and $\rm C_L$ are functions of the application environment (see AC Tables for specific values) $\rm C_L$ includes test fixture and stray capacitance

Figure 10. AC Test Circuit Load



 $\rm R_L$ and $\rm C_L$ are functions of the application environment (see AC Tables for specific values) $\rm C_L$ includes test fixture and stray capacitance

Figure 11. Break-Before-Make Timing

Test Diagrams (Continued)

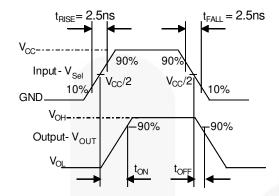


Figure 12. Turn-On / Turn-Off Waveforms

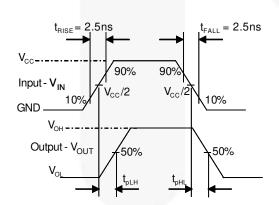


Figure 13. Switch Propagation Delay Waveforms

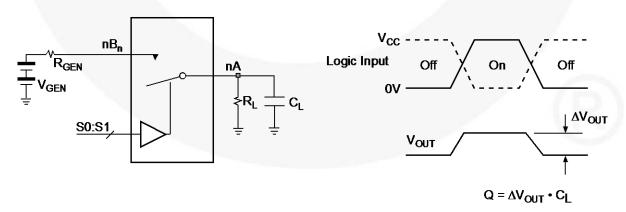


Figure 14. Charge Injection Test

Test Diagrams (Continued)

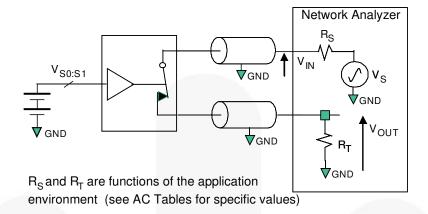


Figure 15. Bandwidth

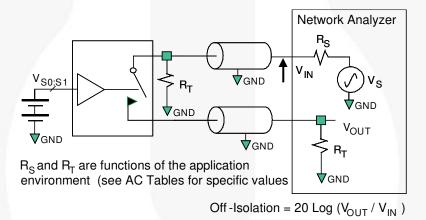


Figure 16. Channel Off Isolation

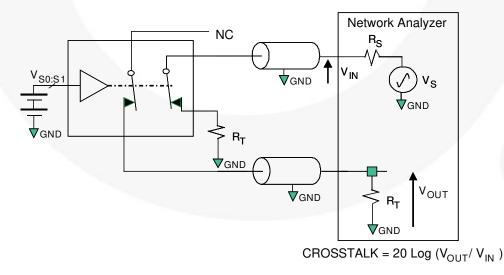


Figure 17. Non-Adjacent Channel-to-Channel Crosstalk

Test Diagrams (Continued)

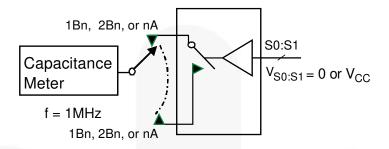


Figure 18. Channel Off Capacitance

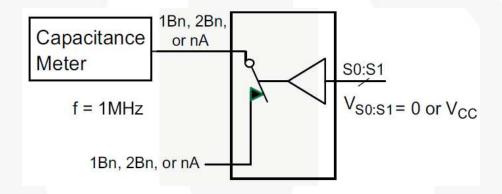


Figure 19. Channel On Capacitance

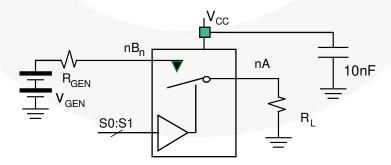
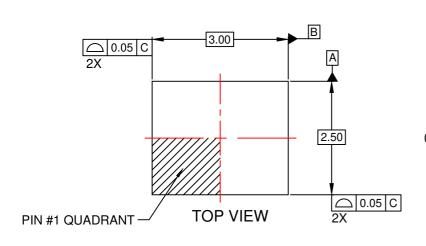
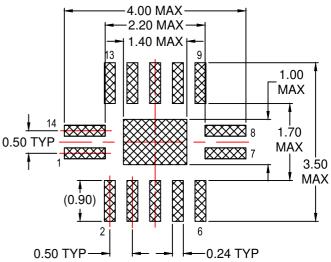
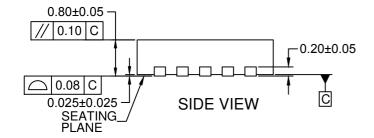


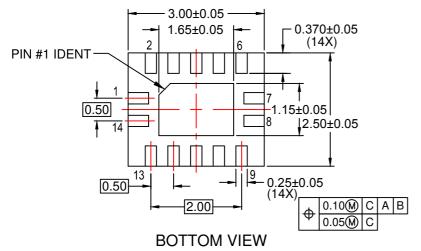
Figure 20. Total Harmonic Distortion







RECOMMENDED LAND PATTERN



NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-241, VARIATION AA
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP14Arev2.



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